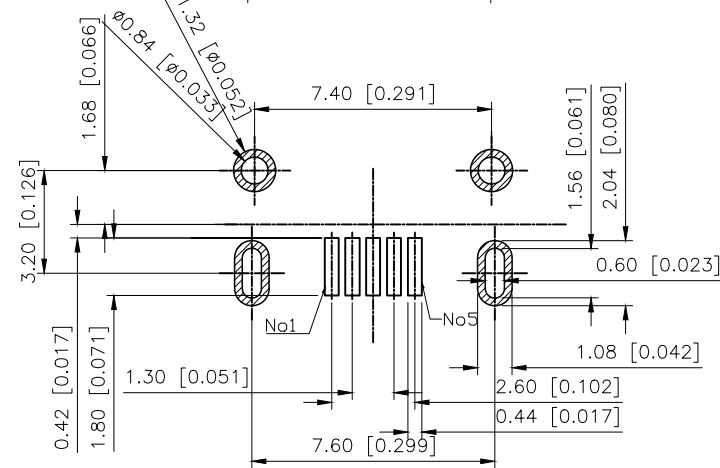
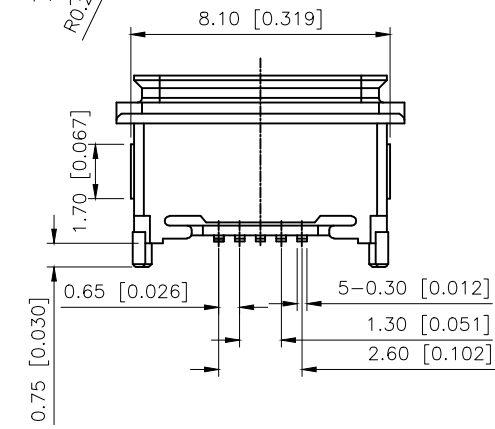
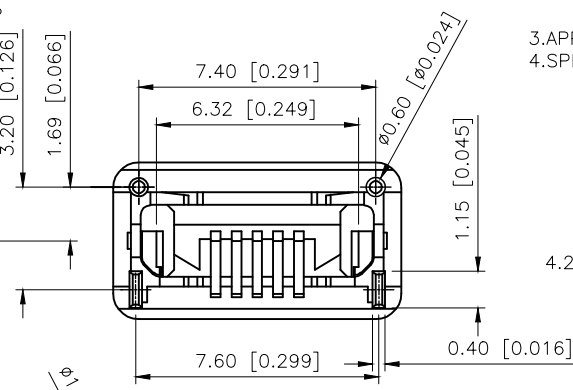
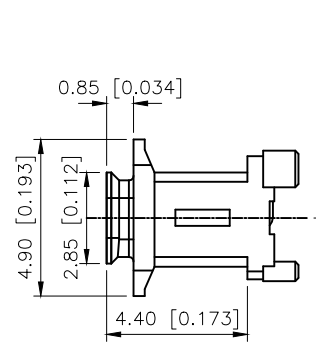
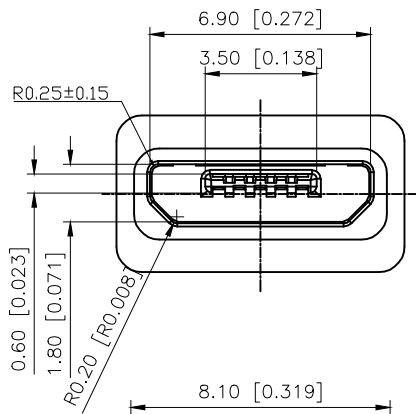
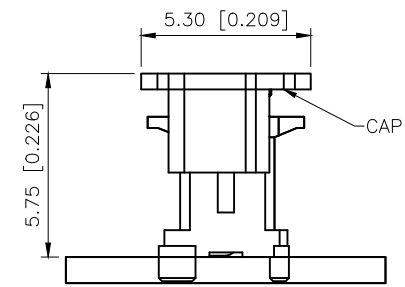
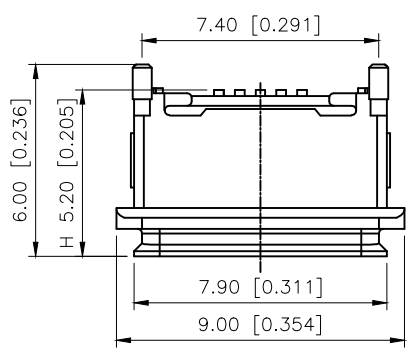
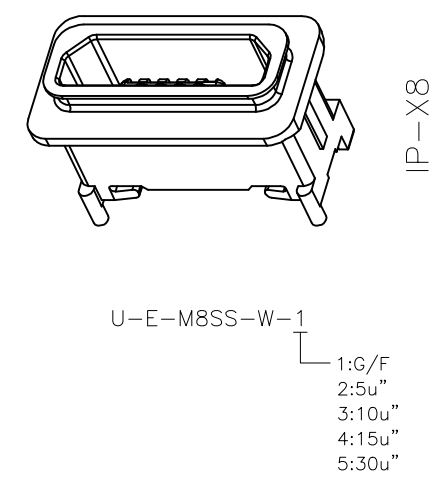


REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	/	/
A1	N/A		图面升级整理图面	2025.03.10	阿树

NOTES:
1.MATERIAL:
HOUSING: THERMOPLASTIC HIGH-TEMP UL94V-0 BLACK COLOR.
CONTACT: COPPER ALLOY
SHELL: STAINLESS STEEL.
2.FINISH:
CONTACT: SEE TABLE 1.
OUT SHELL: 50u"Min. NICKEL ALL OVER
3.APPLIED TO IR SOLDERING PROCESS.
4.SPECIFICATION:
4.1.ELECTRICAL CHARACTERISTICS
CONTACT CURRENT RATING: Signal pin 1A, Power pin 1.8A
VOLTAGE RATING: 30V AC rms.
CONTACT RESISTANCE: 30mΩ MAX.
DIELECTRIC WITHSTANDING VOLTAGE:
UNMATEP CONTACT 100V AC rms. 60MHZ FOR 1 MINUTE.
INSULATION RESISTANCE: 1000MQ MIN. 100V DC
TEMPERATURE RANGE: -30 TO +85
4.2.MECHANICAL:
INSERTION FORCE: 35N MAX.
WITHDRAWAL FORCE: 8N~25N.
DURABILITY: 10,000 CYCLES



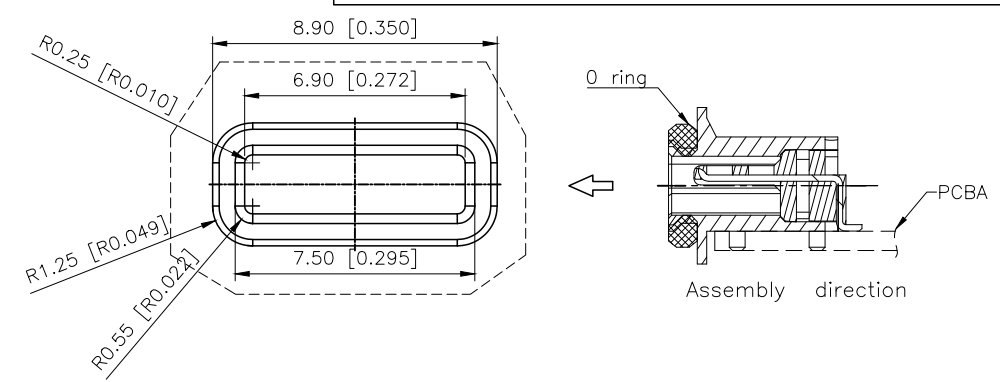
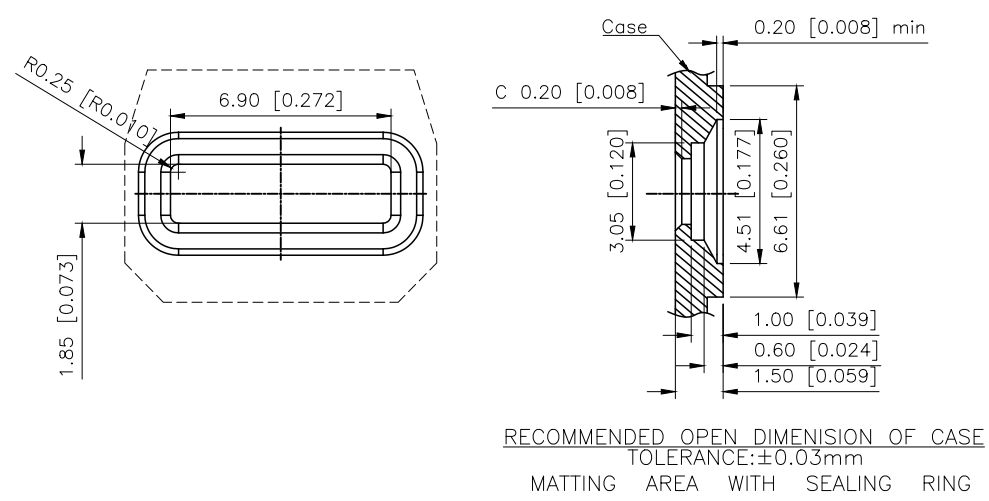
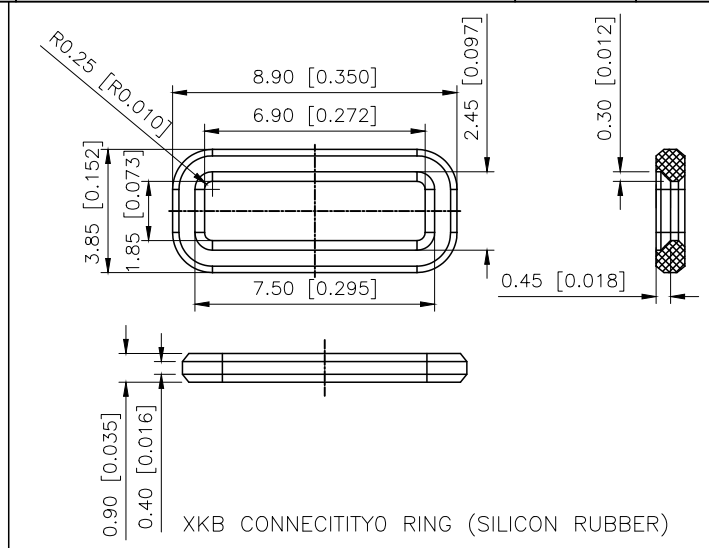
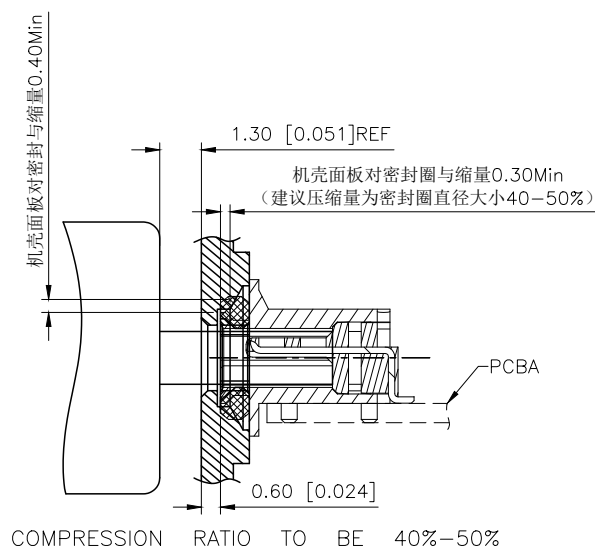
RECOMMENDED PCB LAYOUT
TOLERANCE: ±0.03mm
RECOMMEND PCB THICKNESS: 0.80mm

AuGLAR	±5°
X.	±0.40
X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERANCES	



DESIGN	阿树	VIEW:		MODEL TYPE:	MICRO USB
CHECKED		UNIT:	mm/in	PART NO.:	U-E-M8SS-W-1
APPROVED		SIZE:	A4	DWG NO.:	

REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	/	/
A1	N/A		图面升级整理图面	2025.03.10	阿树



AuGLAR	±5°
X.	±0.40
X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERAUCES	



DESIGN	阿树	VIEW:	MODEL TYPE: MICRO USB
CHECKED		UNIT: mm/in	PART NO.: U-E-M8SS-W-1
APPROVED		SIZE: A4	DWG NO.: